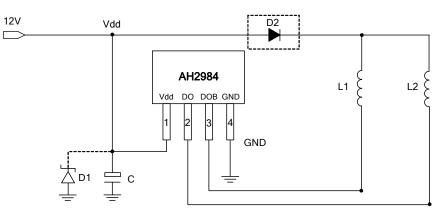


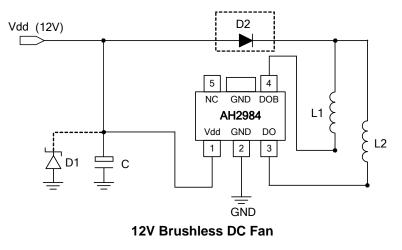
Typical Applications Circuit (Note 4)

(1) For SIP-4



12V Brushless DC Fan

(2) For SOT89-5



Note: 4. D1 (Zener Diode) and Capacitor C are for power stabilization. Recommended value of C is 1μ F/ 50V (E-Cap). Diode D2 is optional and helps to protect the device and fan coils from reverse power conditions. The AH2984 also includes an internal reverse blocking diode at V_{DD} pin.

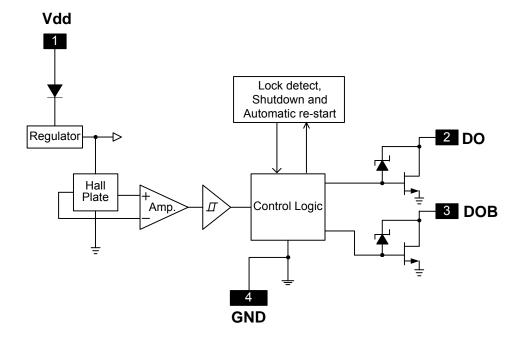
Pin Descriptions

Pin Name	SIP-4	SOT89-5	Description
V _{DD}	1	1	Input Power
DO	2	3	Output Pin
DOB	3	4	Output Pin
GND	4	2	Ground
NC	_	5	No Connection

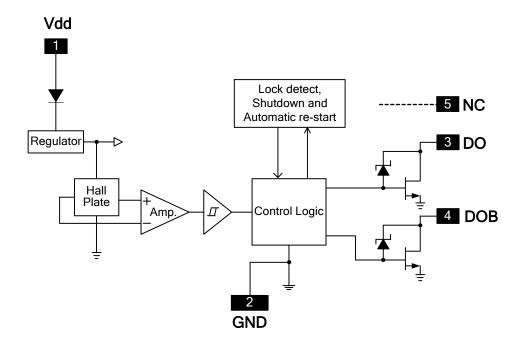


Functional Block Diagram

(1) For SIP-4



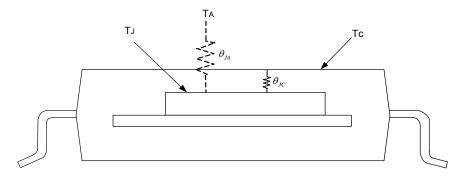
(2) For SOT89-5





Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Symbol	Conditions	Rating	Unit	
V _{DD}	Supply Voltage		18	V
V _{RDD}	Reverse V _{DD} Polarity Voltage		-15	V
I _{O(AVE)}		500		
I _{O(peak as hold)}	Output Current (Note 5)	800	mA	
_		SIP-4	550	mW
PD	Power Dissipation	SOT89-5	800	mW
T _{ST}	Storage Temperature		-55 to +150	°C
TJ	Maximum Junction Temperature		+150	°C
0		SIP-4	227	°C/W
θ _{JA}	Thermal Resistance (Note 6)	SOT89-5	168	°C/W
0		SIP-4	49	°C/W
$\theta_{\rm JC}$	Thermal Resistance (Note 6)	SOT89-5	36	°C/W



Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DD}	Supply Voltage	Operating	2.5	15	V
T _A	Operating Ambient Temperature (Note 5)	Operating	-40	+105	°C

Electrical Characteristics (@T_A = +25°C; V_{DD} = 12V; unless otherwise specified, Note 4)

Symbol	Characteristics	Conditions	Min	Тур.	Max	Unit
IDD	Supply Current	Operating, V _{DD} = 12V	2.0	3.5	5.0	mA
Ton	Locked Protection On Time	_	—	0.25		S
T _{off}	Locked Protection Off Time	—	—	3.25	_	S
R _{duty}	Locked Protection Duty Ratio	T _{off} /T _{on}	—	13	—	_
D	Output On Resistance	I _O = 300mA	—	1	1.67	0
R _{DS(ON)}	Output On Resistance	I _O = 500mA	_	1.25	1.8	Ω
Vz	Output Zener-Breakdown Voltage	(Note 7)	24	33	42	V

Notes: 5. Shall not exceed P_D and Safety Operation Area.

6. θ_{JA} should be confirmed with heat sink thermal resistance. SOT89 exposed pad soldered to minimum recommended landing pads (see Package Outline Dimension section) on 2"x2" two-layer 2oz.copper FR4 PCB with thermal vias in the exposed pad connecting to the copper flood on the bottom layer.

7. The V_Z value is in D.C voltage measurement. The V_Z may vary with coils in A.C. voltage measurements.

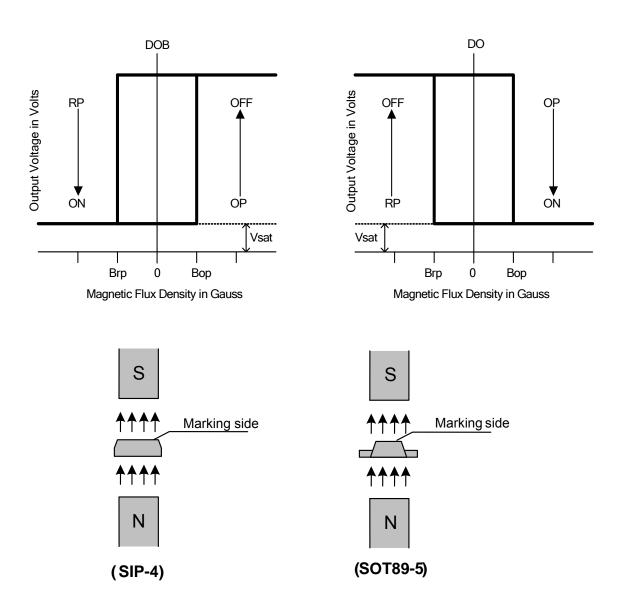


Magnetic Characteristics (T_A = +25°C, V_{DD} = 2.5V to 15V, Note 8)

					(1mT=10 Gauss)
Symbol	Characteristics	Min	Тур.	Max	Unit
BOP	Operate Point	5	30	60	Gauss
B _{RP}	Release Point	-60	-30	-5	Gauss
B _{HY}	Hysteresis	20	60	120	Gauss

Note: 8. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.

Operating Characteristics



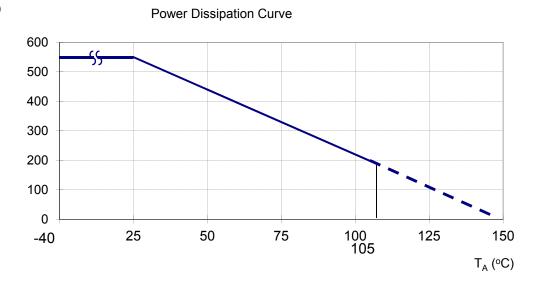


Performance Characteristics

(1) SIP-4

T _A (°C)	25	50	60	70	80	85	90	95	100
P _D (mW)	550	440	396	352	308	286	264	242	220
T _A (°C)	105	110	115	120	125	130	135	140	150
P _D (mW)	198	176	154	132	110	88	66	44	0

P_D (mW)

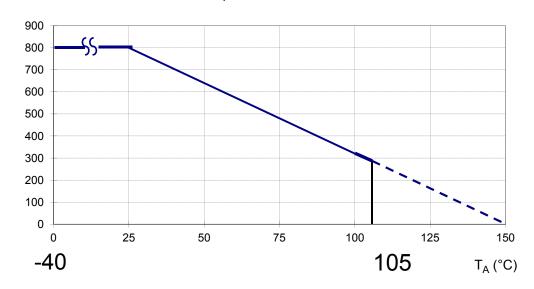


(2) SOT89-5

T _A (°C)	25	50	60	70	75	80	85	90	95	100
P _D (mW)	800	640	576	512	480	448	416	384	352	320
T _A (°C)	105	110	115	120	125	130	135	140	145	150
P _D (mW)	288	256	224	192	160	128	96	64	32	0

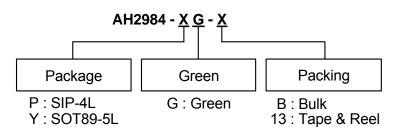
P_D (mW)

Power Dissipation Curve





Ordering Information (Note 9)

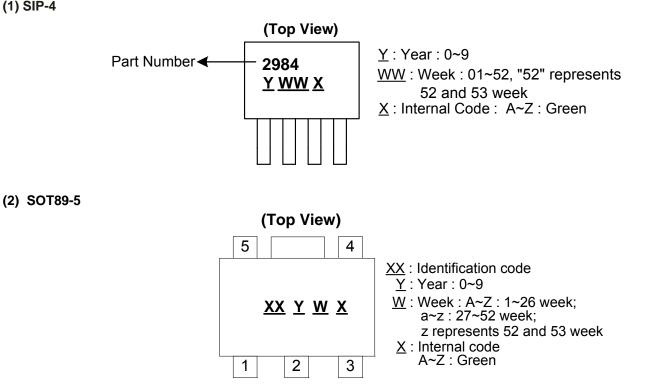


	Pookogo	Pookoging	Bulk		13" Tape and Reel		
Device	Package Code	Packaging (Note 9)	Quantity	Part Number Suffix	Quantity	Part Number Suffix	
AH2984-PG-B	Р	SIP-4	1000	-В	NA	NA	
AH2984-YG-13	Y	SOT89-5	NA	NA	2500/Tape & Reel	-13	

9. For packaging details, go to our website at http://www.diodes.com/products/packages.html Note:

Marking Information

(1) SIP-4

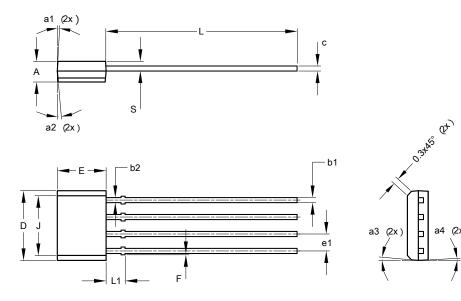


Device	Package	Identification Code
AH2984	SOT89-5	K1



Package Outline Dimensions (All dimensions in mm.)

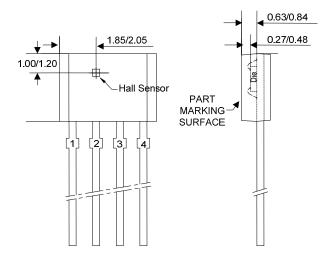
(1) Package type: SIP-4L



	SI	- -4	
Dim	Min	Max	Тур
Α	1.45	1.65	1.55
b1	0.38	0.44	0.40
b2			0.48
С	0.35	0.45	0.40
D	5.12	5.32	5.22
e1	1.24	1.30	1.27
Е	3.55	3.75	3.65
F	0.00	0.20	—
J	4.10	4.30	4.20
L	14.00	14.60	14.30
L1	1.32	1.52	1.42
S	0.63	0.83	0.73
a1	_	5° 7°	3°
a2	4°		5°
a3	4°	7°	5°
a4	_	5°	3°
All	Dimens	ions in	mm

a4 (2x)

Min/Max (in mm)

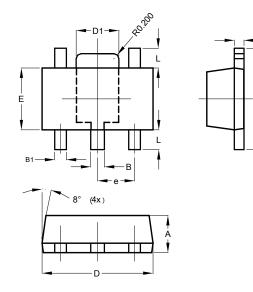




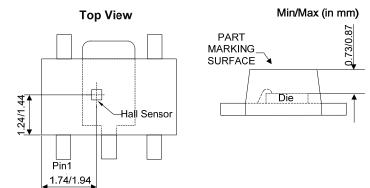
Package Outline Dimensions (All dimensions in mm.)

- C

(2) Package type: SOT89-5L



	SOT89-5							
Dim	Min	Max	Тур					
Α	1.40	1.60	1.50					
В	0.50	0.62	0.56					
B1	0.44	0.54	0.48					
С	0.35	0.43	0.38					
D	4.40	4.60	4.50					
D1	1.62	1.83	1.733					
Е	2.40	2.60	2.50					
е	_	-	1.50					
н	3.95	4.25	4.10					
L	0.65	0.95	0.80					
All	Dimens	sions in	mm					





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